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## REVISION HISTORY

### 3/14—Rev. A to Rev. B

Added Automotive Model .....	Throughout
Changed $\mu$ SOIC Package to MSOP Package .....	Throughout
Updated Outline Dimensions .....	11
Changes to Ordering Guide .....	11
Added Automotive Products Section .....	11

### 2/01—Rev. 0 to Rev. A

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## SPECIFICATIONS

$V_{CC} = 5\text{ V} \pm 10\%$ ,  $C1 = C2 = 0.1\text{ }\mu\text{F}$ . All specifications  $T_{MIN}$  to  $T_{MAX}$  unless otherwise noted.

Table 1.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
Output Voltage Swing	$\pm 3.5$	$\pm 4.2$		V	$V_{CC} = 5\text{ V} \pm 5\%$ , $T_{OUT}$ Loaded with $3\text{ k}\Omega$ to GND
	$\pm 3.25$	$\pm 4.2$		V	$V_{CC} = 5\text{ V} \pm 10\%$ , $T_{OUT}$ Loaded with $3\text{ k}\Omega$ to GND
$V_{CC}$ Power Supply Current (Unloaded)		0.5	1	mA	No Load, $T_{IN} = V_{CC}$ or GND
$V_{CC}$ Power Supply Current (Loaded)		1.85	2.5	mA	$T_{OUT}$ Loaded with $3\text{ k}\Omega$ to GND
$V_{CC}$ Power Supply Current (Shutdown)			1	$\mu\text{A}$	SD Input = $V_{CC}$
Input Logic Threshold Low, $V_{INL}$			0.8	V	
Input Logic Threshold High, $V_{INH}$	2.4			V	
Input Leakage Current			$\pm 1$	$\mu\text{A}$	
RS-232 Input Voltage Range	-15		+15	V	
RS-232 Input Threshold Low	0.8	2.2		V	
RS-232 Input Threshold High		2.4	2.6	V	
RS-232 Input Hysteresis		0.2		V	
RS-232 Input Resistance	3	5	7	$\text{k}\Omega$	
TTL/CMOS Output Voltage Low, $V_{OL}$			0.4	V	$I_{OUT} = 1.6\text{ mA}$
TTL/CMOS Output Voltage High, $V_{OH}$	3.5			V	$I_{OUT} = -1.0\text{ mA}$
Propagation Delay		0.25		$\mu\text{s}$	RS-232 to TTL
Instantaneous Slew Rate <sup>1</sup>		25		V/ $\mu\text{s}$	$C_L = 10\text{ pF}$ , $R_L = 3\text{ k}\Omega - 7\text{ k}\Omega$ , $T_A = 25^\circ\text{C}$
Transition Region Slew Rate		11		V/ $\mu\text{s}$	$R_L = 3\text{ k}\Omega$ , $C_L = 1000\text{ pF}$
					Measured from +3 V to -3 V or Vice Versa
Baud Rate	460			kB	$R_L = 3\text{ k}\Omega$ , $C_L = 1\text{ nF}$
Output Resistance	300			$\Omega$	$V_{CC} = 0\text{ V}$ , $V_{OUT} = \pm 2\text{ V}$
RS-232 Output Short Circuit Current		$\pm 25$	$\pm 60$	mA	

<sup>1</sup> Sample tested to ensure compliance.

## ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$  unless otherwise noted.

Table 2.

Parameter	Rating
$V_{CC}$	6 V
$V_-$	+0.3 V to -6 V
Input Voltages	
Driver Input $T_{IN}$	-0.3 V to ( $V_{CC}$ , +0.3 V)
Receiver Input $R_{IN}$	$\pm 30$ V
Output Voltages	
Driver Output $T_{OUT}$	( $V_{CC}$ , +0.3 V) to ( $V_-$ , -0.3 V)
Receiver Output $R_{OUT}$	-0.3 V to ( $V_{CC}$ +0.3 V)
Short Circuit Duration	
$T_{OUT}$	Continuous
Power Dissipation	
RM-10 (Derate 12 mW/ $^\circ\text{C}$ above $70^\circ\text{C}$ )	1488 mW
Thermal Impedance	135 $^\circ\text{C}/\text{W}$
Operating Temperature Range	
Industrial (A Version)	-40 $^\circ\text{C}$ to +85 $^\circ\text{C}$
Storage Temperature Range	-65 $^\circ\text{C}$ to +150 $^\circ\text{C}$
Lead Temperature Soldering	
Vapor Phase (60 sec)	215 $^\circ\text{C}$
Infrared (15 sec)	220 $^\circ\text{C}$
ESD Rating	>2000 V
ESD Rating (I-O Pins)	15 kV

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### ESD CAUTION



#### ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

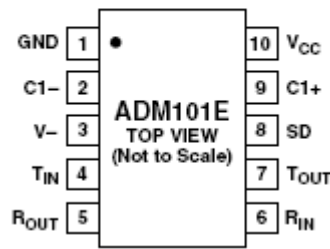


Figure 2. Pin Configuration

Table 3. Pin Function Descriptions

Pin No.	Mnemonic	Function
1	GND	Ground Pin. Must be connected to 0 V.
2	C1–	Negative Terminal of C1 (if C1 is Polarized Capacitor).
3	V–	Internally Generated Negative Supply Voltage.
4	T <sub>IN</sub>	Driver Input (3 V to 5 V TTL/CMOS Logic Levels).
5	R <sub>OUT</sub>	Receiver Output (3 V to 5 V TTL/CMOS Logic Levels).
6	R <sub>IN</sub>	Receiver Input (EIA-232 Signal Levels).
7	T <sub>OUT</sub>	Driver Output (EIA-232 Signal Levels).
8	SD	Shutdown Input. Logic 1 on this input puts the <a href="#">ADM101E</a> into low power shutdown mode.
9	C1+	Positive Terminal of Charge Pump Capacitor (if C1 is Polarized Capacitor).
10	V <sub>CC</sub>	Positive Power Supply, Nominally 5 V.

TYPICAL PERFORMANCE CHARACTERISTICS

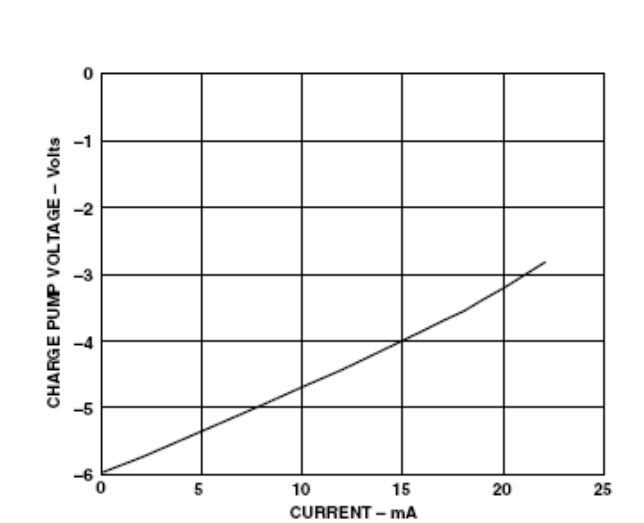


Figure 3. Charge Pump Voltage vs. Current

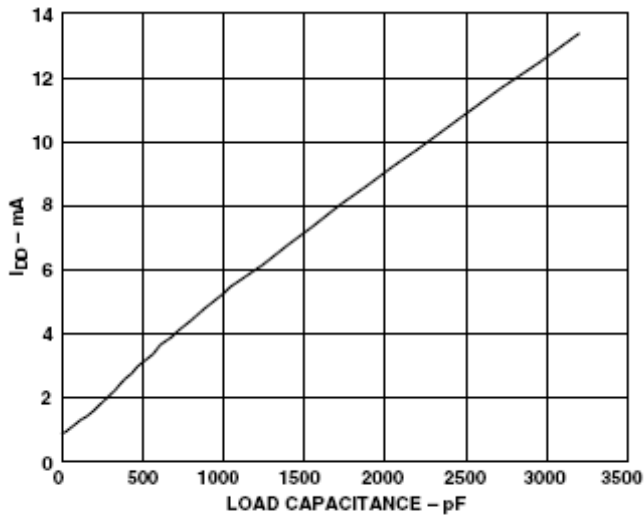


Figure 4. I<sub>DD</sub> vs. Load Capacitance at 460 kbps

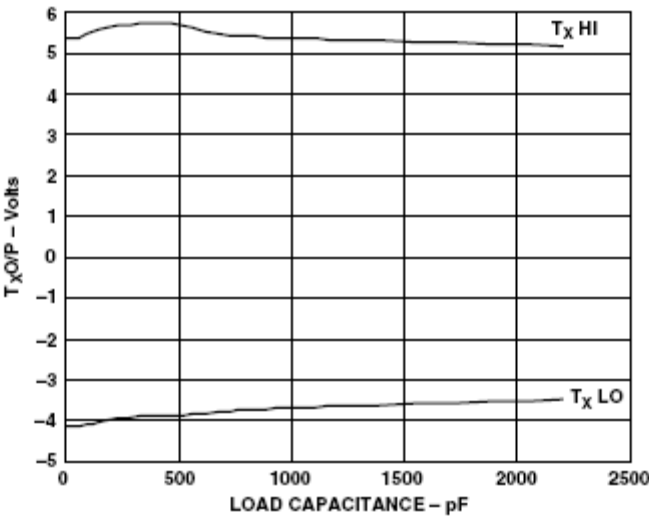


Figure 5. Transmitter Output Voltage vs. Load Capacitance at 460 kbps

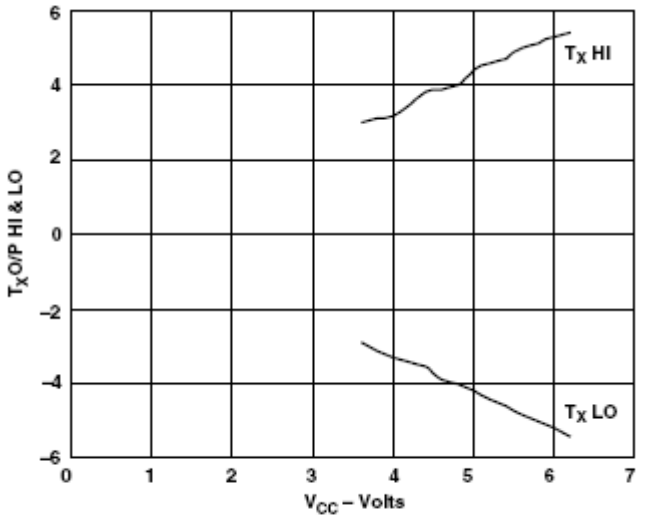


Figure 6. Tx Output Voltage vs. Supply

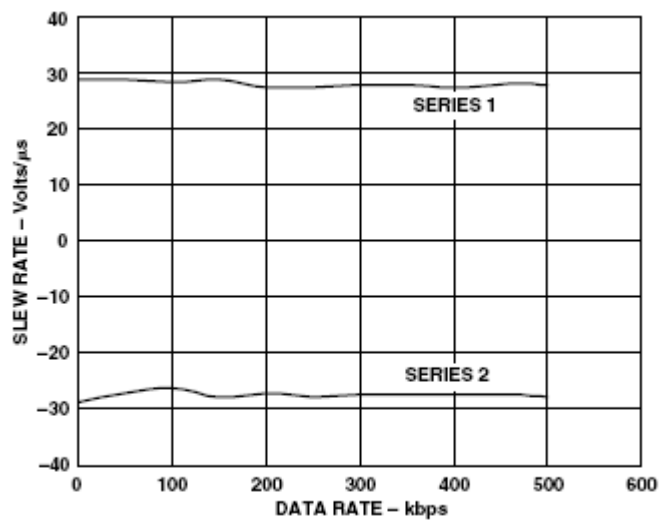


Figure 7. Slew Rate vs. Data Rate

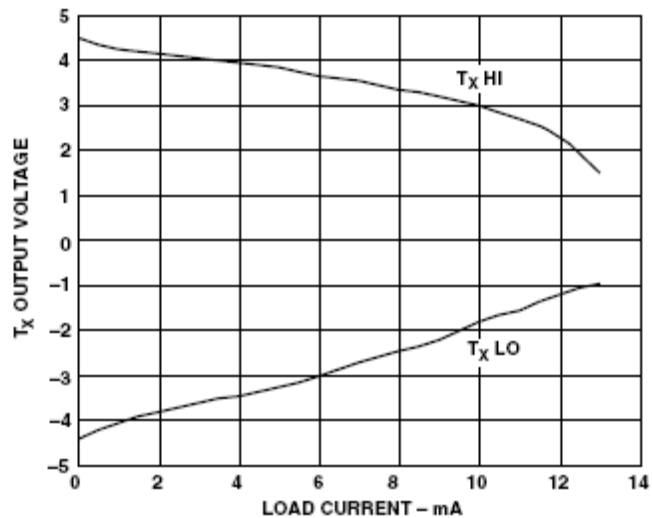


Figure 8. Transmitter Output Voltage vs. Load Current

## GENERAL DESCRIPTION

The [ADM101E](#) is an RS-232 compatible line driver/receiver in the Analog Devices Craft Port series, containing one driver (transmitter) and one receiver. It is ideal for serial communication in small portable devices such as mobile telephones, palmtop personal computers and personal digital assistants, where a full, RS-232 serial interface is not required, and only Tx and Rx lines are required for low speed communication between devices. The [ADM101E](#) operates from a single, 5 V supply, and generates its own, on-chip,  $-5$  V power supply, thus removing the need for a negative power supply for the driver.

## CIRCUIT DESCRIPTION

The internal circuitry consists of three main sections. These are:

1. A charge pump dc-to-dc converter.
2. 5 V logic to EIA-232 driver.
3. EIA-232 to 5 V logic receiver.

### CHARGE PUMP DC-DC CONVERTER

The dc-dc converter generates a negative supply voltage from the 5 V supply, thus removing the need for a separate  $-5$  V rail. It consists of an on-chip 200 kHz oscillator, switching matrix and two external capacitors, as shown in Figure 9.

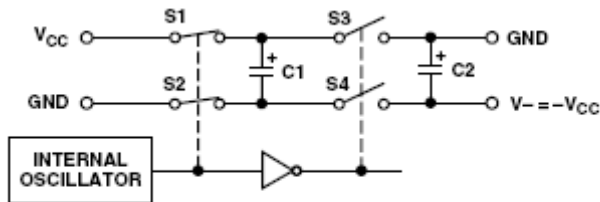


Figure 9. Charge Pump DC-DC Converter

When S1 and S2 are closed, S3 and S4 are open, and C1 charges to  $+V_{CC}$ . S1 and S2 are then opened, while S3 and S4 are closed to connect C1 across C2, dumping charge into C2. Since the positive terminal of C2 is at ground, a negative voltage will be built up on its negative terminal with each cycle of the oscillator. This voltage depends on the current drawn from C2. If the current is small, the voltage will be close to  $-V_{CC}$ , but will fall as the current drawn increases.

### CHARGE PUMP CAPACITORS AND SUPPLY DECOUPLING

For proper operation of the charge pump, the capacitors should have an equivalent series resistance (ESR) less than  $1 \Omega$ . As the charge pump draws current pulses from  $V_{CC}$ , the  $V_{CC}$  decoupling capacitor should also have low ESR. The  $V_{CC}$  decoupling capacitor and  $V-$  reservoir capacitor should also have low ESR because they determine how effectively ESD pulses are clamped to  $V_{CC}$  or  $V-$  by the on-chip clamp diodes. Tantalum or monolithic ceramic capacitors are suitable for these components. If using tantalum capacitors, do not forget to observe polarity.

### TRANSMITTER (DRIVER) SECTION

The driver converts 5 V logic input levels into RS-232 compatible output levels. With  $V_{CC} = 5$  V and driving an EIA-232 load, the output voltage swing is typically  $\pm 4.2$  V.

### RECEIVER SECTION

The receivers are inverting level-shifters that accept EIA-232 input levels and translate them into 5 V logic output levels. The inputs have internal  $5 \text{ k}\Omega$  pull-down resistors to ground and are also protected against overvoltages of up to  $\pm 25$  V. The guaranteed switching thresholds are 0.8 V minimum and 2.8 V maximum. An unconnected receiver input is pulled to 0 V by the internal  $5 \text{ k}\Omega$  pull-down resistor. This, therefore, results in a Logic 1 output level for unconnected inputs or for inputs connected to GND.

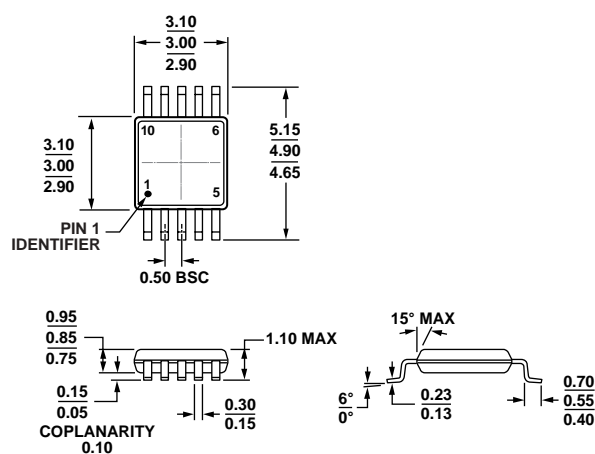
The receivers have Schmitt trigger input with a hysteresis level of 0.25 V. This ensures error-free reception for both noisy inputs and for inputs with slow transition times.



## SHUTDOWN INPUT

The shutdown input allows the [ADM101E](#) to be put into an ultralow power mode where the dc-dc converter is switched off and the transmitter is disabled. The receiver remains active during shutdown. Logic 0 at this input enables the [ADM101E](#), while a Logic 1 at this input shuts down the [ADM101E](#).

## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-187-BA

Figure 10. 10-Lead Mini Small Outline Package [MSOP]  
(RM-10)

Dimensions shown in millimeters

## ORDERING GUIDE

Model <sup>1,2</sup>	Temperature Range	Package Description	Package Option	Branding Code
ADM101EARM	−40°C to +85°C	10-Lead Mini Small Outline Package [MSOP]	RM-10	M01
ADM101EARM-REEL	−40°C to +85°C	10-Lead Mini Small Outline Package [MSOP]	RM-10	M01
ADM101EARM-REEL7	−40°C to +85°C	10-Lead Mini Small Outline Package [MSOP]	RM-10	M01
ADM101EARMZ	−40°C to +85°C	10-Lead Mini Small Outline Package [MSOP]	RM-10	M1
ADM101EARMZ-REEL	−40°C to +85°C	10-Lead Mini Small Outline Package [MSOP]	RM-10	M1
ADM101EARMZ-REEL7	−40°C to +85°C	10-Lead Mini Small Outline Package [MSOP]	RM-10	M1
ADM101EWARMZ-REEL7	−40°C to +85°C	10-Lead Mini Small Outline Package [MSOP]	RM-10	M1

<sup>1</sup> Z = RoHS Compliant Part.

<sup>2</sup> W = Qualified for Automotive Applications.

## AUTOMOTIVE PRODUCTS

The [ADM101EW](#) models are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. Note that these automotive models may have specifications that differ from the commercial models; therefore, designers should review the Specifications section of this data sheet carefully. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.

**NOTES**